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Details

Product Status	Not For New Designs
Core Processor	HC08
Core Size	8-Bit
Speed	8MHz
Connectivity	CANbus, SCI, SPI
Peripherals	LVD, POR, PWM
Number of I/O	37
Program Memory Size	60KB (60K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	A/D 24x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	48-LQFP
Supplier Device Package	48-LQFP (7x7)
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FLASH-2 Memory (FLASH-2)

Programming tools are available from Freescale. Contact your local Freescale representative for more information.

NOTE

A security feature prevents viewing of the FLASH contents.⁽¹⁾

2.7.2 FLASH-2 Control and Block Protect Registers

The FLASH-2 array has two registers that control its operation, the FLASH-2 control register (FL2CR) and the FLASH-2 block protect register (FL2BPR).

2.7.2.1 FLASH-2 Control Register

The FLASH-2 control register (FL2CR) controls FLASH-2 program and erase operations.



Figure 2-7. FLASH-2 Control Register (FL2CR)

HVEN — High-Voltage Enable Bit

This read/write bit enables the charge pump to drive high voltages for program and erase operations in the array. HVEN can only be set if either PGM = 1 or ERASE = 1 and the proper sequence for program or erase is followed.

1 = High voltage enabled to array and charge pump on

0 = High voltage disabled to array and charge pump off

MASS — Mass Erase Control Bit

Setting this read/write bit configures the FLASH-2 array for mass or page erase operation.

1 = Mass erase operation selected

0 = Page erase operation selected

ERASE — Erase Control Bit

This read/write bit configures the memory for erase operation. ERASE is interlocked with the PGM bit such that both bits cannot be set at the same time.

1 = Erase operation selected

0 = Erase operation unselected

PGM — Program Control Bit

This read/write bit configures the memory for program operation. PGM is interlocked with the ERASE bit such that both bits cannot be equal to 1 or set to 1 at the same time.

1 = Program operation selected

0 = Program operation unselected

^{1.} No security feature is absolutely secure. However, Freescale's strategy is to make reading or copying the FLASH difficult for unauthorized users.



Central Processor Unit (CPU)



Figure 7-1. CPU Registers

7.3.1 Accumulator

The accumulator is a general-purpose 8-bit register. The CPU uses the accumulator to hold operands and the results of arithmetic/logic operations.



Figure 7-2. Accumulator (A)

7.3.2 Index Register

The 16-bit index register allows indexed addressing of a 64-Kbyte memory space. H is the upper byte of the index register, and X is the lower byte. H:X is the concatenated 16-bit index register.

In the indexed addressing modes, the CPU uses the contents of the index register to determine the conditional address of the operand.

The index register can serve also as a temporary data storage location.



Figure 7-3. Index Register (H:X)



Source				~	Effect on CCR				SSe	qe	and	Ş
Form	Operation	Description	v	н	1	N	z	С	ddre lode	bco	pera	ycle
JMP opr JMP opr JMP opr,X JMP opr,X JMP ,X	Jump	PC ← Jump Address	_	_	_	_	-	_	₹≥ DIR EXT IX2 IX1 IX	BC CC DC EC FC	dd hh II ee ff ff	2 3 4 3 2
JSR opr JSR opr JSR opr,X JSR opr,X JSR ,X	Jump to Subroutine	$\begin{array}{l} PC \leftarrow (PC) + n \ (n = 1, 2, \mathrm{or} \ 3) \\ Push \ (PCL); \ SP \leftarrow (SP) - 1 \\ Push \ (PCH); \ SP \leftarrow (SP) - 1 \\ PC \leftarrow Unconditional \ Address \end{array}$	_	-	_	_	_	-	DIR EXT IX2 IX1 IX	BD CD DD ED FD	dd hh ll ee ff ff	4 5 6 5 4
LDA #opr LDA opr LDA opr, LDA opr,X LDA opr,X LDA ,X LDA opr,SP LDA opr,SP	Load A from M	A ← (M)	0	_	_	ţ	t	_	IMM DIR EXT IX2 IX1 IX SP1 SP2	A6 B6 C6 D6 E6 F6 9EE6 9ED6	ii dd hh II ee ff ff ff ee ff	23443245
LDHX #opr LDHX opr	Load H:X from M	$H:X \leftarrow (M:M+1)$	0	-	-	ţ	\$	-	IMM DIR	45 55	ii jj dd	3 4
LDX #opr LDX opr LDX opr LDX opr,X LDX opr,X LDX opr,SP LDX opr,SP	Load X from M	X ← (M)	0	_	_	ţ	ţ	_	IMM DIR EXT IX2 IX1 IX SP1 SP2	AE BE CE DE EE FE 9EEE 9EDE	ii dd hh II ee ff ff ff ee ff	23443245
LSL opr LSLA LSLX LSL opr,X LSL ,X LSL ,A LSL opr,SP	Logical Shift Left (Same as ASL)	C ← [] [] ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓	ţ	_	_	ţ	ţ	ţ	DIR INH INH IX1 IX SP1	38 48 58 68 78 9E68	dd ff ff	4 1 4 3 5
LSR opr LSRA LSRX LSR opr,X LSR ,X LSR opr,SP	Logical Shift Right		ţ	_	_	0	ţ	ţ	DIR INH INH IX1 IX SP1	34 44 54 64 74 9E64	dd ff ff	4 1 4 3 5
MOV opr,opr MOV opr,X+ MOV #opr,opr MOV X+,opr	Move	(M) _{Destination} ← (M) _{Source} H:X ← (H:X) + 1 (IX+D, DIX+)	0	_	_	ţ	ţ	_	DD DIX+ IMD IX+D	4E 5E 6E 7E	dd dd dd ii dd dd	5 4 4 4
MUL	Unsigned multiply	$X:A \leftarrow (X) \times (A)$	-	0	-	-	-	0	INH	42		5
NEG opr NEGA NEGX NEG opr,X NEG ,X NEG opr,SP	Negate (Two's Complement)	$\begin{array}{l} M \leftarrow -(M) = \$00 - (M) \\ A \leftarrow -(A) = \$00 - (A) \\ X \leftarrow -(X) = \$00 - (X) \\ M \leftarrow -(M) = \$00 - (M) \\ M \leftarrow -(M) = \$00 - (M) \end{array}$	ţ	_	_	ţ	ţ	ţ	DIR INH INH IX1 IX SP1	30 40 50 60 70 9E60	dd ff ff	4 1 4 3 5
NOP	No Operation	None	-	-	-	-	-	-	INH	9D		1
NSA	Nibble Swap A	A ← (A[3:0]:A[7:4])	_	_	-	-	-	-	INH	62		3
ORA #opr ORA opr ORA opr ORA opr,X ORA opr,X ORA opr,SP ORA opr,SP	Inclusive OR A and M	A ← (A) (M)	0	_	_	ţ	ţ	_	IMM DIR EXT IX2 IX1 IX SP1 SP2	AA BA CA DA EA FA 9EEA 9EDA	ii dd hh II ee ff ff ee ff	23443245
PSHA	Push A onto Stack	Push (A); SP \leftarrow (SP) – 1	-	-	-	-	-	-	INH	87		2
PSHH PSHX	Push H onto Stack Push X onto Stack	Push (H); SP \leftarrow (SP) – 1 Push (X); SP \leftarrow (SP) – 1	-	-	-	-	-	-	INH INH	8B 89		2
	1	$\gamma \gamma $	I	L	I	I	1	I	1	-	1	

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Central Processor Unit (CPU)

Table 7-2, Opcode Map

	Bit Mani	pulation	Branch	nch Read-Modify-Write					Control Register/Memory										
	DIR	DIR	REL	DIR	INH	INH	IX1	SP1	IX	INH	INH	IMM	DIR	EXT	IX2	SP2	IX1	SP1	IX
MSB LSB	0	1	2	3	4	5	6	9E6	7	8	9	Α	В	с	D	9ED	Е	9EE	F
0	5 BRSET0 3 DIR	4 BSET0 2 DIR	3 BRA 2 REL	4 NEG 2 DIR	1 NEGA 1 INH	1 NEGX 1 INH	4 NEG 2 IX1	5 NEG 3 SP1	3 NEG 1 IX	7 RTI 1 INH	BGE 2 REL	2 SUB 2 IMM	3 SUB 2 DIR	SUB 3 EXT	4 SUB 3 IX2	5 SUB 4 SP2	3 SUB 2 IX1	4 SUB 3 SP1	2 SUB 1 IX
1	5 BRCLR0 3 DIR	4 BCLR0 2 DIR	3 BRN 2 REL	5 CBEQ 3 DIR	4 CBEQA 3 IMM	4 CBEQX 3 IMM	5 CBEQ 3 IX1+	6 CBEQ 4 SP1	4 CBEQ 2 IX+	4 RTS 1 INH	3 BLT 2 REL	2 CMP 2 IMM	3 CMP 2 DIR	4 CMP 3 EXT	4 CMP 3 IX2	5 CMP 4 SP2	3 CMP 2 IX1	4 CMP 3 SP1	2 CMP 1 IX
2	5 BRSET1 3 DIR	4 BSET1 2 DIR	3 BHI 2 REL		5 MUL 1 INH	7 DIV 1 INH	3 NSA 1 INH		2 DAA 1 INH		3 BGT 2 REL	2 SBC 2 IMM	3 SBC 2 DIR	4 SBC 3 EXT	4 SBC 3 IX2	5 SBC 4 SP2	3 SBC 2 IX1	4 SBC 3 SP1	2 SBC 1 IX
3	5 BRCLR1 3 DIR	4 BCLR1 2 DIR	3 BLS 2 REL	4 COM 2 DIR	1 COMA 1 INH	1 COMX 1 INH	4 COM 2 IX1	5 COM 3 SP1	3 COM 1 IX	9 SWI 1 INH	3 BLE 2 REL	CPX 2 IMM	3 CPX 2 DIR	4 CPX 3 EXT	4 CPX 3 IX2	5 CPX 4 SP2	3 CPX 2 IX1	4 CPX 3 SP1	2 CPX 1 IX
4	5 BRSET2 3 DIR	4 BSET2 2 DIR	BCC 2 REL	4 LSR 2 DIR	1 LSRA 1 INH	1 LSRX 1 INH	4 LSR 2 IX1	5 LSR 3 SP1	3 LSR 1 IX	2 TAP 1 INH	2 TXS 1 INH	2 AND 2 IMM	3 AND 2 DIR	4 AND 3 EXT	4 AND 3 IX2	5 AND 4 SP2	3 AND 2 IX1	4 AND 3 SP1	2 AND 1 IX
5	5 BRCLR2 3 DIR	4 BCLR2 2 DIR	3 BCS 2 REL	4 STHX 2 DIR	3 LDHX 3 IMM	4 LDHX 2 DIR	3 CPHX 3 IMM		4 CPHX 2 DIR	1 TPA 1 INH	2 TSX 1 INH	BIT 2 IMM	3 BIT 2 DIR	BIT 3 EXT	4 BIT 3 IX2	5 BIT 4 SP2	3 BIT 2 IX1	4 BIT 3 SP1	2 BIT 1 IX
6	5 BRSET3 3 DIR	4 BSET3 2 DIR	3 BNE 2 REL	4 ROR 2 DIR	1 RORA 1 INH	1 RORX 1 INH	4 ROR 2 IX1	5 ROR 3 SP1	3 ROR 1 IX	2 PULA 1 INH		2 LDA 2 IMM	3 LDA 2 DIR	4 LDA 3 EXT	4 LDA 3 IX2	5 LDA 4 SP2	3 LDA 2 IX1	4 LDA 3 SP1	2 LDA 1 IX
7	5 BRCLR3 3 DIR	4 BCLR3 2 DIR	3 BEQ 2 REL	4 ASR 2 DIR	1 ASRA 1 INH	1 ASRX 1 INH	4 ASR 2 IX1	5 ASR 3 SP1	3 ASR 1 IX	2 PSHA 1 INH	1 TAX 1 INH	AIS 2 IMM	3 STA 2 DIR	STA 3 EXT	4 STA 3 IX2	STA 4 SP2	3 STA 2 IX1	4 STA 3 SP1	2 STA 1 IX
8	5 BRSET4 3 DIR	4 BSET4 2 DIR	3 BHCC 2 REL	4 LSL 2 DIR	1 LSLA 1 INH	1 LSLX 1 INH	4 LSL 2 IX1	5 LSL 3 SP1	3 LSL 1 IX	2 PULX 1 INH	1 CLC 1 INH	EOR 2 IMM	3 EOR 2 DIR	4 EOR 3 EXT	4 EOR 3 IX2	5 EOR 4 SP2	3 EOR 2 IX1	4 EOR 3 SP1	2 EOR 1 IX
9	5 BRCLR4 3 DIR	4 BCLR4 2 DIR	3 BHCS 2 REL	4 ROL 2 DIR	1 ROLA 1 INH	1 ROLX 1 INH	4 ROL 2 IX1	5 ROL 3 SP1	3 ROL 1 IX	2 PSHX 1 INH	1 SEC 1 INH	ADC 2 IMM	3 ADC 2 DIR	ADC 3 EXT	4 ADC 3 IX2	ADC 4 SP2	3 ADC 2 IX1	4 ADC 3 SP1	ADC 1 IX
A	5 BRSET5 3 DIR	4 BSET5 2 DIR	3 BPL 2 REL	4 DEC 2 DIR	1 DECA 1 INH	1 DECX 1 INH	4 DEC 2 IX1	5 DEC 3 SP1	3 DEC 1 IX	2 PULH 1 INH	2 CLI 1 INH	ORA 2 IMM	3 ORA 2 DIR	4 ORA 3 EXT	4 ORA 3 IX2	5 ORA 4 SP2	3 ORA 2 IX1	4 ORA 3 SP1	2 ORA 1 IX
в	5 BRCLR5 3 DIR	4 BCLR5 2 DIR	3 BMI 2 REL	5 DBNZ 3 DIR	3 DBNZA 2 INH	3 DBNZX 2 INH	5 DBNZ 3 IX1	6 DBNZ 4 SP1	4 DBNZ 2 IX	2 PSHH 1 INH	2 SEI 1 INH	2 ADD 2 IMM	3 ADD 2 DIR	4 ADD 3 EXT	4 ADD 3 IX2	5 ADD 4 SP2	3 ADD 2 IX1	4 ADD 3 SP1	2 ADD 1 IX
с	5 BRSET6 3 DIR	4 BSET6 2 DIR	3 BMC 2 REL	4 INC 2 DIR	1 INCA 1 INH	1 INCX 1 INH	4 INC 2 IX1	5 INC 3 SP1	3 INC 1 IX	1 CLRH 1 INH	1 RSP 1 INH		2 JMP 2 DIR	3 JMP 3 EXT	4 JMP 3 IX2		3 JMP 2 IX1		2 JMP 1 IX
D	5 BRCLR6 3 DIR	4 BCLR6 2 DIR	3 BMS 2 REL	3 TST 2 DIR	1 TSTA 1 INH	1 TSTX 1 INH	3 TST 2 IX1	4 TST 3 SP1	2 TST 1 IX		1 NOP 1 INH	4 BSR 2 REL	4 JSR 2 DIR	JSR 3 EXT	6 JSR 3 IX2		5 JSR 2 IX1		4 JSR 1 IX
E	5 BRSET7 3 DIR	4 BSET7 2 DIR	3 BIL 2 REL		5 MOV 3 DD	4 MOV 2 DIX+	4 MOV 3 IMD		4 MOV 2 IX+D	1 STOP 1 INH	*	2 LDX 2 IMM	3 LDX 2 DIR	4 LDX 3 EXT	4 LDX 3 IX2	5 LDX 4 SP2	3 LDX 2 IX1	4 LDX 3 SP1	2 LDX 1 IX
F	5 BRCLR7 3 DIR	4 BCLR7 2 DIR	3 BIH 2 REL	3 CLR 2 DIR	1 CLRA 1 INH	1 CLRX 1 INH	3 CLR 2 IX1	4 CLR 3 SP1	CLR 1 IX	1 WAIT 1 INH	1 TXA 1 INH	AIX 2 IMM	STX 2 DIR	STX 3 EXT	4 STX 3 IX2	5 STX 4 SP2	3 STX 2 IX1	4 STX 3 SP1	2 STX 1 IX

INH Inherent IMM Immediate REL Relative IX Indexed, No Offset DIR Direct EXT Extended IX1 IX2

- Indexed, 8-Bit Offset Indexed, 16-Bit Offset
- DD Direct-Direct IMD Immediate-Direct IX+D Indexed-Direct DIX+ Direct-Indexed

IX1+ Indexed, 1-Byte Offset with Post Increment

SP1 Stack Pointer, 8-Bit Offset SP2 Stack Pointer, 16-Bit Offset IX+ Indexed, No Offset with

Post Increment

Low Byte of Opcode in Hexadecimal

5 Cycles BRSET0 Opcode Mnemonic 3 DIR Number of Bytes / Addressing Mode

High Byte of Opcode in Hexadecimal

MSB

LSB

0

0

*Pre-byte for stack pointer indexed instructions



10.12 Timer Interface Module (TIM1 and TIM2)

10.12.1 Wait Mode

The timer interface modules (TIM) remain active in wait mode. Any enabled CPU interrupt request from the TIM can bring the MCU out of wait mode.

If TIM functions are not required during wait mode, reduce power consumption by stopping the TIM before executing the WAIT instruction.

10.12.2 Stop Mode

The TIM is inactive in stop mode. The STOP instruction does not affect register states or the state of the TIM counter. TIM operation resumes when the MCU exits stop mode after an external interrupt.

10.13 Timebase Module (TBM)

10.13.1 Wait Mode

The timebase module (TBM) remains active after execution of the WAIT instruction. In wait mode, the timebase register is not accessible by the CPU.

If the timebase functions are not required during wait mode, reduce the power consumption by stopping the timebase before enabling the WAIT instruction.

10.13.2 Stop Mode

The timebase module may remain active after execution of the STOP instruction if the oscillator has been enabled to operate during stop mode through the OSCENINSTOP bit in the CONFIG2 register. The timebase module can be used in this mode to generate a periodic wakeup from stop mode.

If the oscillator has not been enabled to operate in stop mode, the timebase module will not be active during stop mode. In stop mode, the timebase register is not accessible by the CPU.

If the timebase functions are not required during stop mode, reduce the power consumption by stopping the timebase before enabling the STOP instruction.

10.14 Scalable Controller Area Network Module (MSCAN)

10.14.1 Wait Mode

The scalable controller area network (MSCAN) module remains active after execution of the WAIT instruction. In wait mode, the MSCAN08 registers are not accessible by the CPU.

If the MSCAN08 functions are not required during wait mode, reduce the power consumption by disabling the MSCAN08 module before enabling the WAIT instruction.

10.14.2 Stop Mode

The MSCAN08 module is inactive in stop mode. The STOP instruction does not affect MSCAN08 register states.

Because the internal clock is inactive during stop mode, entering stop mode during an MSCAN08 transmission or reception results in invalid data.

MC68HC908GZ60 • MC68HC908GZ48 • MC68HC908GZ32 Data Sheet, Rev. 6

Freescale Semiconductor



Input/Output (I/O) Ports

Addr.	Register Name		Bit 7	6	5	4	3	2	1	Bit 0	
\$0004	Data Direction Register A (DDRA)	Read: Write:	DDRA7	DDRA6	DDRA5	DDRA4	DDRA3	DDRA2	DDRA1	DDRA0	
	See page 174.	Reset:	0	0	0	0	0	0	0	0	
Data Direc \$0005	Data Direction Register B (DDRB)	Read: Write:	DDRB7	DDRB6	DDRB5	DDRB4	DDRB3	DDRB2	DDRB1	DDRB0	
	See page 176.	Reset:	0	0	0	0	0	0	0	0	
\$0006	Data Direction Register C	Read:	0	DDRC6	DDRC5	DDRC4	DDRC3	DDRC2	DDRC1	DDRC0	
20000	See page 178.	Popot:	0	0	0	0	0	0	0	0	
		Resel.	0	0	0	0	0	0	0	0	
\$0007	Data Direction Register D (DDRD)	Write:	DDRD7	DDRD6	DDRD5	DDRD4	DDRD3	DDRD2	DDRD1	DDRD0	
	See page 181.	Reset:	0	0	0	0	0	0	0	0	
Port E Data Register \$0008 (PTE) See page 183	Port E Data Register	Read:	0	0	PTE5	PTF4	PTE3	PTF2	PTF1	PTEO	
	(PTE)	Write:			TTES	1 124	1120	1122		TILO	
	See page 183.	Reset:	Unaffected by reset								
\$000C	Data Direction Register E	Read:	0	0	DDBE5	DDRE4	DDBE3	DDBE2	DDRF1	DDBE0	
	(DDRE) See page 184	Write:			BBREO	BBRET	BBREO	DDIILL	BBRET	BBREO	
	See page 164.	Reset:	0	0	0	0	0	0	0	0	
\$000D	Port A Input Pullup Enable Register (PTAPUE)	Read: Write:	PTAPUE7	PTAPUE6	PTAPUE5	PTAPUE4	PTAPUE3	PTAPUE2	PTAPUE1	PTAPUE0	
	See page 175.	Reset:	0	0	0	0	0	0	0	0	
	Port C Input Pullup Enable	Read:	0	DTODUES	DTODUES						
\$000E	Register (PTCPUE)	Write:		FICFUED	FICFUED	PICPUE4	FICFUES	PIGPUE2	PICPUEI	FICFUEU	
	See page 180.	Reset:	0	0	0	0	0	0	0	0	
\$000F	Port D Input Pullup Enable Register (PTDPUE)	Read: Write:	PTDPUE7	PTDPUE6	PTDPUE5	PTDPUE4	PTDPUE3	PTDPUE2	PTDPUE1	PTDPUE0	
	See page 182.	Reset:	0	0	0	0	0	0	0	0	
\$0440	Port F Data Register (PTF) See page 185	Read: Write:	PTF7	PTF6	PTF5	PTF4	PTAF3	PTF2	PTF1	PTF0	
	000 page 100.	Reset:				Unaffecte	d by reset				
\$0441	Port G Data Register (PTG) See page 186	Read: Write:	PTG7	PTG6	PTG5	PTG4	PTG3	PTG2	PTG1	PTG0	
	dee page 100.	Reset:	Unaffected by reset						I		
				= Unimpleme	ented						

Figure 13-1. I/O Port Register Summary (Sheet 2 of 3)



Input/Output (I/O) Ports

13.3.2 Data Direction Register A

Data direction register A (DDRA) determines whether each port A pin is an input or an output. Writing a 1 to a DDRA bit enables the output buffer for the corresponding port A pin; a 0 disables the output buffer.



Figure 13-3. Data Direction Register A (DDRA)

DDRA7–DDRA0 — Data Direction Register A Bits

These read/write bits control port A data direction. Reset clears DDRA7–DDRA0, configuring all port A pins as inputs.

1 = Corresponding port A pin configured as output

0 = Corresponding port A pin configured as input

NOTE

Avoid glitches on port A pins by writing to the port A data register before changing data direction register A bits from 0 to 1.

Figure 13-4 shows the port A I/O logic.

When bit DDRAx is a 1, reading address \$0000 reads the PTAx data latch. When bit DDRAx is a 0, reading address \$0000 reads the voltage level on the pin. The data latch can always be written, regardless of the state of its data direction bit. Table 13-2 summarizes the operation of the port A pins.







Enhanced Serial Communications Interface (ESCI) Module



SL = 1 -> SCI_CLK = BUSCLK SL = 0 -> SCI_CLK = CGMXCLK

Figure 14-3. ESCI Module Block Diagram





If start bit verification is not successful, the RT clock is reset and a new search for a start bit begins.

To determine the value of a data bit and to detect noise, recovery logic takes samples at RT8, RT9, and RT10. Table 14-3 summarizes the results of the data bit samples.

RT8, RT9, and RT10 Samples	Data Bit Determination	Noise Flag
000	0	0
001	0	1
010	0	1
011	1	1
100	0	1
101	1	1
110	1	1
111	1	0

Table 14-3. Data Bit Recovery

NOTE

The RT8, RT9, and RT10 samples do not affect start bit verification. If any or all of the RT8, RT9, and RT10 start bit samples are 1s following a successful start bit verification, the noise flag (NF) is set and the receiver assumes that the bit is a start bit.

To verify a stop bit and to detect noise, recovery logic takes samples at RT8, RT9, and RT10. Table 14-4 summarizes the results of the stop bit samples.

RT8, RT9, and RT10 Samples	Framing Error Flag	Noise Flag
000	1	0
001	1	1
010	1	1
011	0	1
100	1	1
101	0	1
110	0	1
111	0	0

Table 14-4. Stop Bit Recovery

14.4.3.4 Framing Errors

If the data recovery logic does not detect a 1 where the stop bit should be in an incoming character, it sets the framing error bit, FE, in SCS1. A break character also sets the FE bit because a break character has no stop bit. The FE bit is set at the same time that the SCRF bit is set.



Enhanced Serial Communications Interface (ESCI) Module

IDLE — Receiver Idle Bit

This clearable, read-only bit is set when 10 or 11 consecutive 1s appear on the receiver input. IDLE generates an ESCI receiver CPU interrupt request if the ILIE bit in SCC2 is also set. Clear the IDLE bit by reading SCS1 with IDLE set and then reading the SCDR. After the receiver is enabled, it must receive a valid character that sets the SCRF bit before an idle condition can set the IDLE bit. Also, after the IDLE bit has been cleared, a valid character must again set the SCRF bit before an idle condition can set the IDLE bit. Reset clears the IDLE bit.

1 = Receiver input idle

0 = Receiver input active (or idle since the IDLE bit was cleared)

OR — Receiver Overrun Bit

This clearable, read-only bit is set when software fails to read the SCDR before the receive shift register receives the next character. The OR bit generates an ESCI error CPU interrupt request if the ORIE bit in SCC3 is also set. The data in the shift register is lost, but the data already in the SCDR is not affected. Clear the OR bit by reading SCS1 with OR set and then reading the SCDR. Reset clears the OR bit.

1 = Receive shift register full and SCRF = 1

0 = No receiver overrun

Software latency may allow an overrun to occur between reads of SCS1 and SCDR in the flag-clearing sequence. Figure 14-14 shows the normal flag-clearing sequence and an example of an overrun caused by a delayed flag-clearing sequence. The delayed read of SCDR does not clear the OR bit because OR was not set when SCS1 was read. Byte 2 caused the overrun and is lost. The next flag-clearing sequence reads byte 3 in the SCDR instead of byte 2.



Figure 14-14. Flag Clearing Sequence



PSSB[4:3:2:1:0]	Prescaler Divisor Fine Adjust (PDFA)
00101	5/32 = 0.15625
00110	6/32 = 0.1875
00111	7/32 = 0.21875
01000	8/32 = 0.25
01001	9/32 = 0.28125
0 1 0 1 0	10/32 = 0.3125
01011	11/32 = 0.34375
0 1 1 0 0	12/32 = 0.375
01101	13/32 = 0.40625
0 1 1 1 0	14/32 = 0.4375
01111	15/32 = 0.46875
10000	16/32 = 0.5
10001	17/32 = 0.53125
10010	18/32 = 0.5625
10011	19/32 = 0.59375
10100	20/32 = 0.625
10101	21/32 = 0.65625
10110	22/32 = 0.6875
10111	23/32 = 0.71875
1 1 0 0 0	24/32 = 0.75
1 1 0 0 1	25/32 = 0.78125
1 1 0 1 0	26/32 = 0.8125
1 1 0 1 1	27/32 = 0.84375
1 1 1 0 0	28/32 = 0.875
1 1 1 0 1	29/32 = 0.90625
1 1 1 1 0	30/32 = 0.9375
11111	31/32 = 0.96875

Table 14-10.	ESCI Prescaler	Divisor Fine	Adjust ((Continued)
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Use the following formula to calculate the ESCI baud rate:

Baud rate = $\frac{\text{Frequency of the SCI clock source}}{64 \text{ x BPD x BD x (PD + PDFA)}}$

where:

Frequency of the SCI clock source = f_{Bus} or CGMXCLK (selected by

SCIBDSRC in the CONFIG2 register)

BPD = Baud rate register prescaler divisor

BD = Baud rate divisor

PD = Prescaler divisor

PDFA = Prescaler divisor fine adjust

Table 14-11 shows the ESCI baud rates that can be generated with a 4.9152-MHz bus frequency.



Chapter 15 System Integration Module (SIM)

15.1 Introduction

This section describes the system integration module (SIM). Together with the central processor unit (CPU), the SIM controls all microcontroller unit (MCU) activities. A block diagram of the SIM is shown in Figure 15-1. Table 15-1 is a summary of the SIM input/output (I/O) registers. The SIM is a system state controller that coordinates CPU and exception timing.

The SIM is responsible for:

- Bus clock generation and control for CPU and peripherals:
 - Stop/wait/reset/break entry and recovery
 - Internal clock control
- Master reset control, including power-on reset (POR) and computer operating properly (COP) timeout
- Interrupt arbitration

Table 15-1 shows the internal signal names used in this section.

Signal Name	Description
CGMXCLK	Buffered version of OSC1 from clock generator module (CGM)
CGMVCLK	PLL output
CGMOUT	PLL-based or OSC1-based clock output from CGM module (Bus clock = CGMOUT divided by two)
IAB	Internal address bus
IDB	Internal data bus
PORRST	Signal from the power-on reset module to the SIM
IRST	Internal reset signal
R/W	Read/write signal

Table 15-1. Signal Name Conventions





16.7 Interrupts

Four SPI status flags can be enabled to generate CPU interrupt requests. See Table 16-1.

Flag	Request
SPTE	SPI transmitter CPU interrupt request
Transmitter empty	(SPTIE = 1, SPE = 1)
SPRF	SPI receiver CPU interrupt request
Receiver full	(SPRIE = 1)
OVRF	SPI receiver/error interrupt request
Overflow	(ERRIE = 1)
MODF	SPI receiver/error interrupt request
Mode fault	(ERRIE = 1)

Table 16-1. SPI Interrupts

Reading the SPI status and control register with SPRF set and then reading the receive data register clears SPRF. The clearing mechanism for the SPTE flag is always just a write to the transmit data register.

The SPI transmitter interrupt enable bit (SPTIE) enables the SPTE flag to generate transmitter CPU interrupt requests, provided that the SPI is enabled (SPE = 1).

The SPI receiver interrupt enable bit (SPRIE) enables SPRF to generate receiver CPU interrupt requests, regardless of the state of SPE. See Figure 16-12.



Figure 16-12. SPI Interrupt Request Generation

The error interrupt enable bit (ERRIE) enables both the MODF and OVRF bits to generate a receiver/error CPU interrupt request.

The mode fault enable bit (MODFEN) can prevent the MODF flag from being set so that only the OVRF bit is enabled by the ERRIE bit to generate receiver/error CPU interrupt requests.



Timebase Module (TBM)

17.7 Timebase Control Register

The timebase has one register, the timebase control register (TBCR), which is used to enable the timebase interrupts and set the rate.



Figure 17-2. Timebase Control Register (TBCR)

TBIF — Timebase Interrupt Flag

This read-only flag bit is set when the timebase counter has rolled over.

- 1 = Timebase interrupt pending
- 0 = Timebase interrupt not pending

TBR2–TBR0 — Timebase Divider Selection Bits

These read/write bits select the tap in the counter to be used for timebase interrupts as shown in Table 17-1.

NOTE

Do not change TBR2–TBR0 bits while the timebase is enabled (TBON = 1).

TACK— Timebase Acknowledge Bit

The TACK bit is a write-only bit and always reads as 0. Writing a 1 to this bit clears TBIF, the timebase interrupt flag bit. Writing a 0 to this bit has no effect.

1 = Clear timebase interrupt flag

0 = No effect

TBIE — Timebase Interrupt Enabled Bit

This read/write bit enables the timebase interrupt when the TBIF bit becomes set. Reset clears the TBIE bit.

1 = Timebase interrupt is enabled.

0 = Timebase interrupt is disabled.

TBON — Timebase Enabled Bit

This read/write bit enables the timebase. Timebase may be turned off to reduce power consumption when its function is not necessary. The counter can be initialized by clearing and then setting this bit. Reset clears the TBON bit.

1 = Timebase is enabled.

0 = Timebase is disabled and the counter initialized to 0s.





20.3 Monitor Module (MON)

The monitor module allows debugging and programming of the microcontroller unit (MCU) through a single-wire interface with a host computer. Monitor mode entry can be achieved without use of the higher test voltage, V_{TST} , as long as vector addresses \$FFFE and \$FFFF are blank, thus reducing the hardware requirements for in-circuit programming.

Features of the monitor module include:

- Normal user-mode pin functionality
- One pin dedicated to serial communication between MCU and host computer
- Standard non-return-to-zero (NRZ) communication with host computer
- Standard communication baud rate (7200 @ 2-MHz bus frequency)
- Execution of code in random-access memory (RAM) or FLASH
- FLASH memory security feature⁽¹⁾
- FLASH memory programming interface
- Monitor mode entry without high voltage, V_{TST}, if reset vector is blank (\$FFFE and \$FFFF contain \$FF)
- Normal monitor mode entry if V_{TST} is applied to IRQ

20.3.1 Functional Description

Figure 20-9 shows a simplified diagram of the monitor mode.

The monitor module receives and executes commands from a host computer.

Figure 20-10 and Figure 20-11 show example circuits used to enter monitor mode and communicate with a host computer via a standard RS-232 interface.

Simple monitor commands can access any memory address. In monitor mode, the MCU can execute code downloaded into RAM by a host computer while most MCU pins retain normal operating mode functions. All communication between the host computer and the MCU is through the PTA0 pin. A level-shifting and multiplexing interface is required between PTA0 and the host computer. PTA0 is used in a wired-OR configuration and requires a pullup resistor.

Table 20-1 shows the pin conditions for entering monitor mode. As specified in the table, monitor mode may be entered after a power-on reset (POR) and will allow communication at 7200 baud provided one of the following sets of conditions is met:

- If \$FFFE and \$FFFF does not contain \$FF (programmed state):
 - The external clock is 4.0 MHz (7200 baud)
 - PTB4 = low
 - IRQ = V_{TST}
- If \$FFFE and \$FFFF do not contain \$FF (programmed state):
 - The external clock is 8.0 MHz (7200 baud)
 - PTB4 = high
 - IRQ = V_{TST}
- If \$FFFE and \$FFFF contain \$FF (erased state):
 - The external clock is 8.0 MHz (7200 baud)
 - $\overline{IRQ} = V_{DD}$ (this can be implemented through the internal \overline{IRQ} pullup) or V_{SS}

^{1.} No security feature is absolutely secure. However, Freescale's strategy is to make reading or copying the FLASH difficult for unauthorized users.



Development Support



Table 20-4. WRITE (Write Memory) Command



Description	Read next 2 bytes in memory from last address accessed					
Operand	None					
Data Returned	Returns contents of next two addresses					
Opcode	\$1A					
Command Sequence						
FROM HOST						

Table 20-6. IWRITE (Indexed Write) Command



A sequence of IREAD or IWRITE commands can access a block of memory sequentially over the full 64-Kbyte memory map.



21.15 Memory Characteristics

Characteristic	Symbol	Min	Тур	Max	Unit
RAM data retention voltage	V _{RDR}	1.3	—		V
FLASH program bus clock frequency	—	1	_		MHz
FLASH read bus clock frequency	f _{Read} ⁽¹⁾	0	—	8 M	Hz
FLASH page erase time <1 k cycles >1 k cycles	t _{Erase}	0.9 3.6	1 4	1.1 5.5	ms
FLASH mass erase time	t _{MErase}	4	—		ms
FLASH PGM/ERASE to HVEN setup time	t _{NVS}	10	—	_	μS
FLASH high-voltage hold time	t _{NVH}	5	—		μS
FLASH high-voltage hold time (mass erase)	t _{NVHL}	100	—		μS
FLASH program hold time	t _{PGS}	5	—	_	μS
FLASH program time	t _{PROG}	30	—	40	μS
FLASH return to read time	t _{RCV} ⁽²⁾	1	—		μS
FLASH cumulative program HV period	t _{HV} ⁽³⁾	—	—	4	ms
FLASH endurance ⁽⁴⁾	—	10 k	100 k	_	Cycles
FLASH data retention time ⁽⁵⁾	_	15	100	_	Years

1. $f_{\mbox{Read}}$ is defined as the frequency range for which the FLASH memory can be read.

2. t_{RCV} is defined as the time it needs before the FLASH can be read after turning off the high voltage charge pump, by clearing HVEN to 0.

3. t_{HV} is defined as the cumulative high voltage programming time to the same row before next erase.

 t_{HV} must satisfy this condition: $t_{NVS} + t_{NVH} + t_{PGS} + (t_{PROG} \times 32) \le t_{HV}$ maximum. 4. Typical endurance was evaluated for this product family. For additional information on how Freescale defines *Typical* Endurance, please refer to Engineering Bulletin EB619.

5. Typical data retention values are based on intrinsic capability of the technology measured at high temperature and de-rated to 25°C using the Arrhenius equation. For additional information on how Freescale defines Typical Data Retention, please refer to Engineering Bulletin EB618.





DETAIL "A"

SECTION B-B



DETAIL "C"

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